### 503598799 12/07/2015

### PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
KAZUHIRO HAMAMOTO	11/24/2015
YOICHI USUI	11/24/2015

#### **RECEIVING PARTY DATA**

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Postal Code:	161-8525

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number			
Application Number:	14896411			

#### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	Q223906		
NAME OF SUBMITTER:	ALEXANDER E. AUERBACH, NEW APP SPEC		
SIGNATURE:	/Alexander E. Auerbach/		
DATE SIGNED:	12/07/2015		
This document serves as an Oath/Declaration (37 CFR 1.63).			

#### **Total Attachments: 4**

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PATENT 503598799 REEL: 037222 FRAME: 0099

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Docket No.: Claiming Foreign Priority

#### ASSIGNMENT WITH DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

Whereas, I/We, the undersigned inventor(s) hereinafter called assignor(s), have invented certain improvements described in the application identified below; and

Whereas, HOYA CORPORATION, 7-5, Naka-Ochiai 2-chome, Shinjuku-ku, Tokyo 161-8525, Japan, (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, and all countries foreign thereto, including rights of priority under the International Convention of Paris (1883) as amended, including the right to claim priority under 35 U.S.C. §119, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we hereby agree that the assignee may apply for foreign Letters Patent on the invention and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States and foreign applications when called upon to do so by the assignee.

•		_	
As the below named	inventor, I hereby	declar	e that:
This assignment with directed to:	declaration is		The attached application, or
entotod to.		X	United States Application or PCT International Application Number <u>PCT/JP2014/074993</u> filed on <u>September 22, 2014</u> (Confirmation No).
The application is ent	titled:		

## CONDUCTIVE FILM COATED SUBSTRATE, MULTILAYER REFLECTIVE FILM COATED SUBSTRATE, REFLECTIVE MASK BLANK, REFLECTIVE MASK, AND SEMICONDUCTOR DEVICE MANUFACTURING METHOD

The above identified application was made or was authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. §261)

I have reviewed and understand the contents of the application for which this assignment with declaration is being submitted.

I am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR 1.56.

I hereby acknowledge that any willful false statement made in this assignment with declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

#### Authorization To Permit Access To Application by Participating Office

☑ If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), the Korean Intellectual Property Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual property offices in which a foreign application claiming priority to the above-identified application is filed access to the above-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the applicant does not wish the EPO, JPO, KIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified application is filed to have access to the application.

In accordance with 37 CFR 1.14(h)(3), access will be provided to a copy of the application-as-filed with respect to: 1) the above-identified patent application-as-filed, 2) any foreign application to which the above-identified application claims priority under 35 USC 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the above-identified patent application, and 3) any U.S. application-as-filed from which benefit is sought in the above-identified patent application.

In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Office.

NAME OF SOLE OR FIRST INVENTOR:	-3		-1/4.
Given Name			
(first and middle [if any]) Kazuhiro	Family Name or Surnan	ne	НАМАМОТО
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3 / 1			
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55555555555555555555555555555555555555	, , , , , , , , , , , , , , , , , , , ,		
NAME OF SECOND INVENTOR:		**********	·
Given Name			A TOTAL IS
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Residence: Tokyo, Japan			
Mailing Address: c/o HOYA CORPORATION, 7-5, Naka-Ochiai 2-ch	ome, Shinjuku-ku, Tokyo	161-852	25, Japan
NAME OF THIRD INVENTOR:			
Given Name			
(first and middle [if any])	Family Name or Surname		
	*r***		
Inventor's signature		Date	
nronos sugnauto			
Residence:			
Academoo.			
Mailing Address:			
SESSOR PROGRAMMENT CONTRACTOR CON			
NAME OF FOURTH INVENTOR:	**************************************		
Given Name			
(first and middle [if any])	Family Name or Surname	<u>}</u>	
Inventor's signature		Date	
Residence:		,	
Mailing			
Address:			
NAME OF FIFTH INVENTOR:			
Given Name			
(first and middle [if any])	Family Name or Surname	•	
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Inventor's signature	1	Date	
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Address:	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		

Docket No.: Claiming Foreign Priority

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Whereas, I/We, the undersigned inventor(s) hereinafter called assignor(s), have invented certain improvements described in the application identified below; and

Whereas, HOYA CORPORATION, 7-5, Naka-Ochiai 2-chome, Shinjuku-ku, Tokyo 161-8525, Japan, (assignce), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, and all countries foreign thereto, including rights of priority under the International Convention of Paris (1883) as amended, including the right to claim priority under 35 U.S.C. §119, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we hereby agree that the assignee may apply for foreign Letters Patent on the invention and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States and foreign applications when called upon to do so by the assignee.

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As the below named inventor, I hereby	declar	re that:	
This assignment with declaration is directed to:		The attached application, or	
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		OF OUR OWN LODG ACUT OUT ASSOCIATION WHEN EXCENSES FOR ME ACO APPEN STREETS APP	

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NAME OF SOLE OR FIRST INVENTOR:					
Given Name					
(first and middle [if any]) Kazuhiro	Family Name or Sumame	НАМАМОТО			
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Inventor's signature Yolchi Usui	a	Date November 24, 2015			
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Inventor's signature		Pate			
Residence:					
Mailing Address:					
NAME OF FOURTH INVENTOR:					
Given Name (first and middle [if any])	Family Name or Surname				
Inventor's signature	Da	te			
Residence:					
Mailing Address:					
NAME OF FIFTH INVENTOR:					
Given Name (first and middle [if any])	Family Name or Surname				
Inventor's signature	Da	ite			
Residence:					
Mailing Address:					

PATENT REEL: 037222 FRAME: 0104

**RECORDED: 12/07/2015**